



May 2023

High Performance Automotive 2/4 Ports LVDS Fanout Buffer

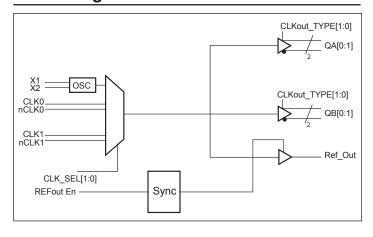
Description

The DIODES PI6C492150xTQ is an automotive high-performance LVDS fanout buffer device which supports up to 1.5GHz frequency. This device is ideal for systems that need to distribute low-jitter clock signals to multiple destinations.

Application(s)

- Networking Systems, including Switches and Routers
- High-Frequency Backplane-based Computing and Telecom Platforms
- **ADAS**
- Automotive Infotainment

Block Diagram



Features

- 2/4 LVDS Outputs with 2 Banks
- LVCMOS Reference Output Up to 200MHz
- Up to 1.5GHz Output Frequency for Differential Outputs
- Ultra-low Additive Phase Jitter: <0.03ps (differential 156.25MHz, 12KHz to 20MHz integration range)
- Selectable Reference Inputs Support either Single-ended or Differential or Xtal
- Low Skew Between Outputs within Banks (<40ps)
- Low Delay from Input to Output (Tpd typ. <1.5ns)
- Separate Input Output Supply Voltage for Level Shifting
- 2.5V / 3.3V Power Supply
- AEC-Q100 Qualified, Automotive Grade 1 Support
- Ambient Operating Temperature: -40°C to 125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The PI6C492150xTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

- Packaging (Pb-free & Green):
 - 32-pin WQFN (ZHW)

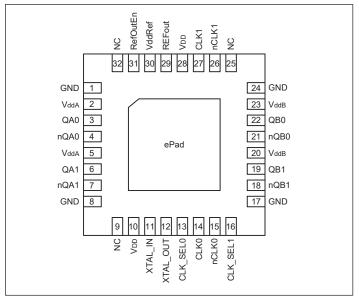
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q100 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.



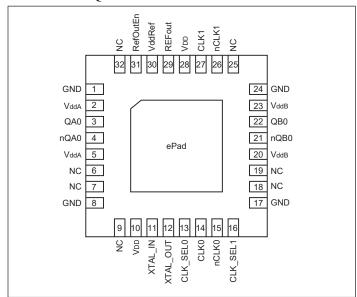


Pin Configuration

PI6C4921504TQ



PI6C4921502TQ



Pin Description

PI6C4921504TQ Pin #	PI6C4921502TQ Pin#	Pin Name	Туре	Description
1, 8, 17, 24	1, 8, 17, 24	GND	Power	Negative power supply
9, 25, 32	6, 7, 9, 18, 19, 25, 32	NC	-	Not Connect
2, 5	2, 5	$V_{\rm ddA}$	Power	Power supply for Bank A Output buffers. V_{ddA} operates from 3.3V or 2.5V
13	13	CLK_SEL0	Input	Clock input source selection pin
16	16	CLK_SEL1	Input	Clock input source selection pin
14,	14,	CLK0	T	D.C
15	15	nCLK0	Input	Differential clock input
27,	27,	CLK1	T	D.G. (1111)
26	26	nCLK1	Input	Differential clock input
11	11	XTAL_In	Input	Input for crystal, XO, or single ended clock
12	12	XTAL_Out	Output	Output for crystal. Leave Xtal_Out floating if Xtal_In is driven by a single ended clock
10, 28	10, 28	V_{DD}	Power	Power supply for core
18,		nQB1	0.4.	D:0
19	_	QB1	Output	Differential output clock
21,	21,	nQB0	Ontro	D: C
22	22	QB0	Output	Differential output clock





PI6C4921504TQ Pin #	PI6C4921502TQ Pin#	Pin Name	Туре	Description
29	29	Ref_Out	Output	Reference output clock
7, 6	_	nQA1 QA1	Output	Differential output clock
4, 3	4, 3	nQA0 QA0	Output	Differential output clock
ePad	ePad	ePad	GND	Connect to the PCB ground
20, 23	20, 23	V_{ddB}	Power	Power supply for Bank B Output buffers. V _{ddB} operates from 3.3 V or 2.5V
30	30	VddRef	Power	Power supply for reference clock output
31	31	RefOutEn	Input	REFout enable input





Function Table

Table 1: Input Selection

CLK_SEL1	CLK_SEL0	Selected Input
0	0	CLK0, nCLK0
0	1	CLK1, nCLK1
1	X	XTAL_In

Table 2: Reference Output Enable

REFout_EN	REFout STATE
0	Disabled (Hi-Z)
1	Enabled

Table 3: CLKx Input vs. Output States

State of Selected Input Clock	State of Enabled Outputs
CLKx and nCLKx	Logic Low
Inputs Floating	Logic Low
CLKx and nCLKx	N. C. A. L. O. A. C. H. L. C. L.
Inputs Shorted Together	Not Supported. Output is Undefined
CLKx Logic Low	Logic Low
CLKx Logic High	Logic High





Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested)

Storage Temperature55 to +150°C
Supply Voltage to Ground Potential (V $_{\text{DD}}, V_{\text{DDO}})$ -0.5 to +4.6V
Inputs (Referenced to GND)0.5 to $V_{\text{\tiny DD}}\text{+}0.5V$
Clock Output (Referenced to GND)0.5 to $V_{\mbox{\scriptsize DD}} + 0.5 V$
Latch Up200mA
ESD Protection (Input)2000V min (HBM)
Junction Temperature 150 °C max

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Power Supply Characteristics and Operating Conditions

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
$V_{\scriptscriptstyle DD}$	Core Supply Voltage		2.375		3.465	V
$V_{ m DDO}$	Output Supply Voltage	$V_{DDO} \le V_{DD}$	2.375		3.465	V
$I_{ m DD}$	Core Power Supply Current	All LVDS Loaded		50	65	
$I_{ m DDO}$	Output Power Supply Current	All LVDS Loaded		35	46	mA
T_A	Ambient Operating Temperature(1)	LVDS output	-40		125	°C

Note:

DC Electrical Specifications - Differential Inputs

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
I_{IH}	Input High current	$Input = V_{DD}$			150	uA
$I_{\scriptscriptstyle \mathrm{IL}}$	Input Low current	Input = GND	-150			uA
C_{IN}	Input capacitance			3		PF
V_{IH}	Input high voltage				V _{DD} +0.3	V
V_{IL}	Input low voltage		-0.3			V
$ m V_{ID}$	Input Differential Amplitude PK-PK		0.15		1.3	V
V_{CM}	Common model input voltage		0.25		V _{DD} -1.2	V
ISO_{MUX}	MUX isolation			-89		dBc

DC Electrical Specifications - LVCMOS Inputs

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
I_{IH}	Input High current	$Input = V_{DD}$			150	uA

^{1.} Either T_A used as operating condition





Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
I_{IL}	Input Low current	Input = GND	-150			uA
V_{IH}	Input high voltage	$V_{\rm DD} = 3.3 \mathrm{V}$	2.0		V _{DD} +0.3	V
V_{IL}	Input low voltage	$V_{\rm DD} = 3.3 V$	-0.3		0.8	V
V _{IH}	Input high voltage	$V_{\rm DD} = 2.5 V$	1.7		V _{DD} +0.3	V
V _{IL}	Input low voltage	$V_{DD} = 2.5V$	-0.3		0.7	V

DC Electrical Specifications- LVDS Outputs

Parameter	Description	Conditions	Min.	Тур.	Max.	Units
V _{OH}	Output High voltage		1.4	1.5	1.6	V
V_{OL}	Output Low voltage		1	1.1	1.25	V
Vocm	Output commode voltage		1.2	1.3	1.45	V
DVocm	Change in Vocm between completely output states				50	mV

DC Electrical Specifications – LVCMOS Outputs

Parameter	Description	Conditions	Min.	Тур.	Max.	Units
3.7		$V_{\rm DDO} = 3.3 V + /-5\%, I_{\rm OH} = -8 m A$	2.3			V
V _{OH}	Output High voltage	$V_{\rm DDO} = 2.5 V$ +/- 5%, $I_{\rm OH} = -8 m A$	1.5			V
***		$V_{\rm DDO} = 3.3 V + /-5\%, I_{\rm OL} = 8 m A$			0.5	V
V _{OL} (C	Output Low voltage	$V_{\rm DDO} = 2.5 V$ +/- 5%, $I_{\rm OL} = 8 m A$			0.4	V
3 7	0 () () ()	$V_{\rm DDO} = 3.3 V + /-5\%, I_{\rm OH} = -24 mA$	2.1			V
V _{OH}	Output High voltage	$V_{\rm DDO} = 2.5 V$ +/- 5%, $I_{\rm OH} = -16 m A$	1.5			V
	Output Low voltage	$V_{\rm DDO} = 3.3 V + /-5\%, I_{\rm OL} = 24 m A$			1	V
V _{OL}		$V_{\rm DDO} = 2.5 V$ +/- 5%, $I_{\rm OL} = 16 mA$			0.8	V

AC Electrical Specifications – LVDS Outputs

Parameter	Description	Conditions		Min.	Тур.	Max.	Units
F_{OUT}	Clock output frequency	LVDS				1500	MHz
$T_{\rm r}$	Output rise time	From 20% to 80%	LVDS	100	150	300	ps
$T_{\rm f}$	Output fall time	From 80% to 20%	LVDS	100	150	300	ps





Parameter	Description	Conditions	Min.	Тур.	Max.	Units		
${ m T}_{ m ODC}$	Output duty cycle	Frequency < 650MHz, $V_{ID} \ge 400 mV$	LVDS	47		53		
		Frequency < 1GHz, $V_{ID} \ge 400 \text{mV}$	LVDS	45		55	%	
		Frequency < 1.5GHz, $V_{ID} \ge 400 \text{mV}$	LVDS	40		60		
$V_{ ext{pp}}$	Output swing Single-ended	LVDS outputs @ <1GHz		250		600	17	
		LVDS outputs @ >1GHz		250		550	mV	
T_{j}	D 0 11:0 "11 DMC	156.25MHz, 12kHz to 20MHz			0.02		ps	
	Buffer additive jitter RMS	156.25MHz, 10kHz to 1	MHz		0.01		ps	
T_{SK}	Output Skew	4 outputs devices, outputs in same bank, with same load, at DUT.			15	40	ps	
T_{PD}	Propagation Delay	LVDS @ 3.3V, 100MHz			570		ps	
T_{OD}	Valid to HiZ	lid to HiZ				200	ns	
T_{OE}	HiZ to valid				200	ns		
T _{P2P Skew}	Part to Part Skew ⁽¹⁾				80	120	ps	

AC Electrical Specifications – CMOS

(Operating Temperatures -40°C to 125°C)

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
F_{OUT}	Ref_Out frequency	XTAL input	10		50	MHz
		Reference input			200	MHz
T_{j}	Buffer additive jitter RMS	XTAL input		0.3		ps
		Reference input		0.03		ps
$t_{\rm r/}t_{\rm f}$	Rise time, Fall time	$C_{\rm L} = 5 {\rm pF}$		0.8		ns
$T_{ m ODC}$	Output duty cycle	$C_L = 5pF$ 3.3V, max test freq. 200MHz	45		55	%
t_{PD}	Propagation delay	2.5V, max test freq. 150MHz 3.3V, 25MHz		4500		ps
t_{S}	Setup time		300			ps
t_{SOD}	Clock edge to output disable	Ref_Out	2		4	cycles
t _{SOE}	Clock edge to output enable	Ref_Out	2		4	cycles
R_{IUT}	Output Impedance	$V_{\rm DDO}$ = 3.3V ± 5%		30		Ω
		$V_{\rm DDO} = 2.5 V \pm 5\%$		45		Ω

Notes:

^{1.} This parameter is guaranteed by design





Crystal Characteristics

Parameter	Min.	Тур.	Max.	Units
Mode of Oscillation		Fundamental		
Frequency Range	10		50	MHz
Equivalent Series Resistance (ESR)			70	Ω
Shunt Capacitance			7	pF
Load Capacitance	10		18	pF
Drive Level			500	μW

Recommended Crystals

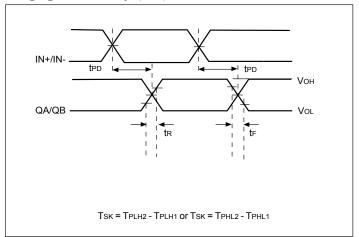
Diodes Recommends:

- a) GC2500003 XTAL 49S/SMD(4.0 mm), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/GC_GF.pdf
- b) FY2500091, SMD 5x3.2(4P), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/FY_F9.pdf
- c) FL2500047, SMD 3.2x2.5(4P), 25M, CL=18pF, +/-20ppm http://www.pericom.com/pdf/datasheets/se/FL.pdf

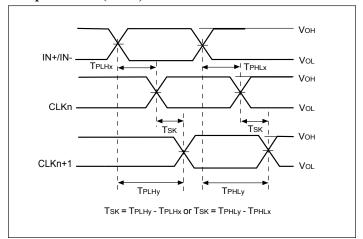




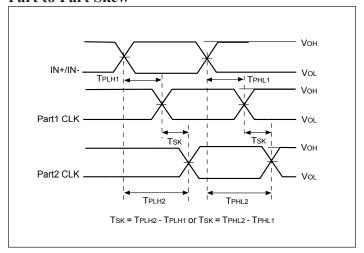
Propagation Delay (TPD)



Output Skew (TSK)



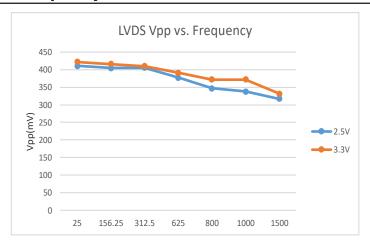
Part to Part Skew



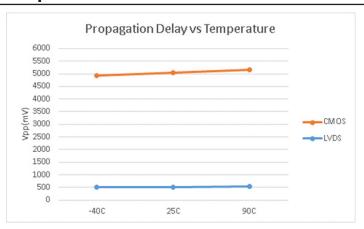




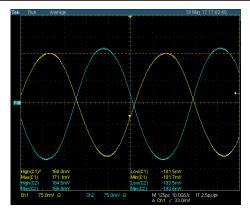
LVDS Output Swing vs. Frequency



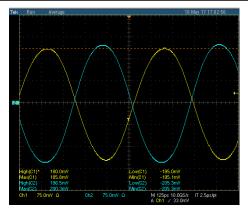
Propagation Delay vs Temperature



1.5GHz LVDS Waveform



2.5V LVDS Waveform



3.3V LVDS Waveform



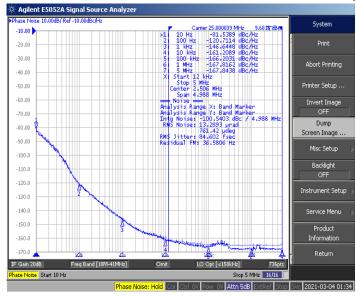


Phase Noise and Additive Jitter

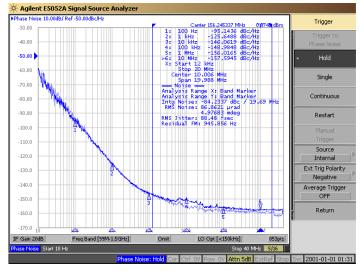
Output phase noise (Dark Blue) vs Input Phase noise (light blue)

Additive jitter is calculated at 25MHz ~71fS RMS (12kHz to 5MHz). Additive jitter = $\sqrt{\text{Output jitter}^2 - \text{Input jitter}^2}$)

Ref_out 25MHz Phase Noise Plot, VDD=VDDO=3.3V, 25°C, Driven by 25MHz CMOS XO



156.25M LVDS Output Additive Jitter Noise Plot, 3.3V

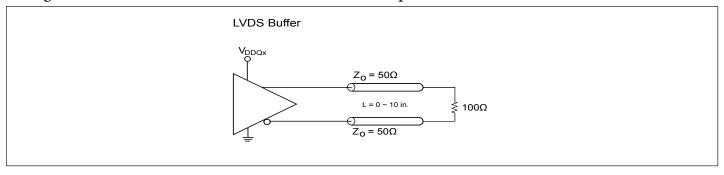


3.3V LVDS Output Jitter 88fs vs. Input 72fs

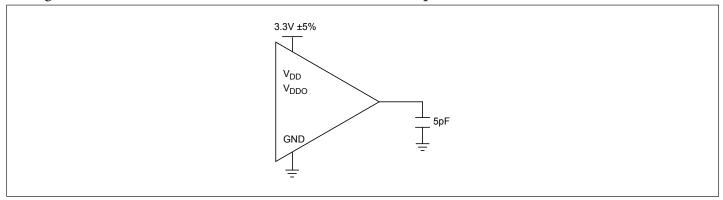




Configuration Test Load Board Termination for LVDS Outputs



Configuration Test Load Board Termination for LVCMOS Outputs







Application Information

Wiring the differential input to accept single ended levels

Figure 1 shows how the differential input can be wired to accept single ended levels. The reference voltage $V_REF = V_{DD}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and $V_{DD} = 3.3$ V, V_REF should be 1.25V and R2/R1 = 0.609.

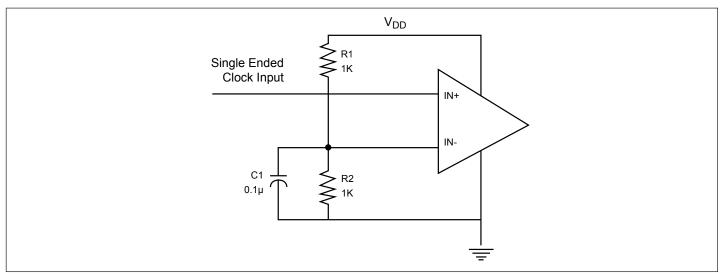
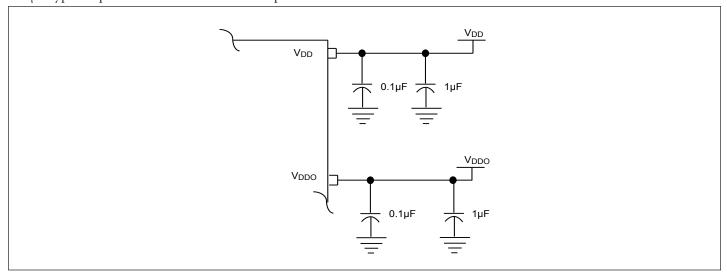


Figure 1. Single-ended Input to Differential Input Device

Power Supply Filtering Techniques

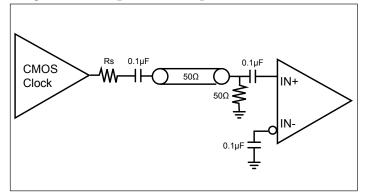
As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. To achieve optimum jitter performance, power supply isolation is required. All power pins should be individually connected to the power supply plane through vias, and $0.1\mu F$ an $1\mu F$ bypass capacitors should be used for each pin.



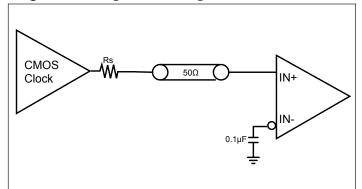




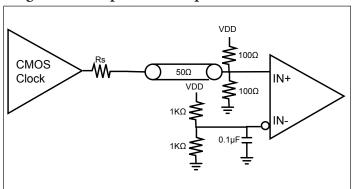
Single Ended Input, AC Couple



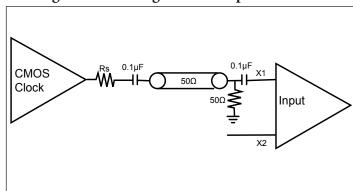
Single Ended Input, DC Couple



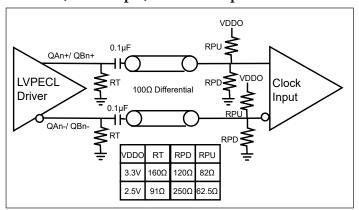
Single Ended Input, DC Couple



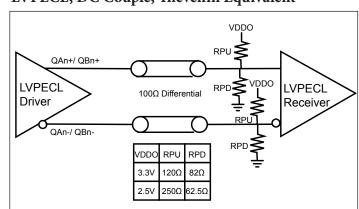
Driving X1 with a Single Ended Input



LVPECL, AC Couple, Thevenin Equivalent



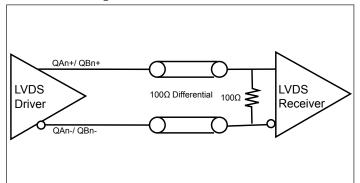
LVPECL, DC Couple, Thevenin Equivalent



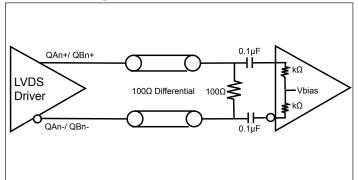




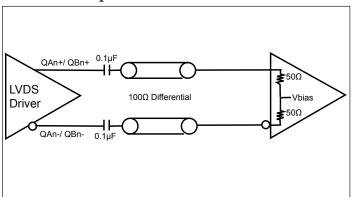
LVDS DC Couple



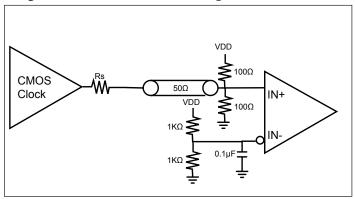
LVDS AC Couple at Load



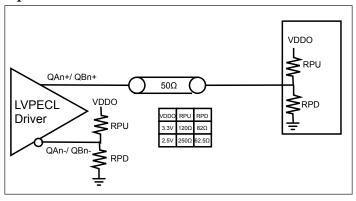
LVDS AC Couple with Internal Termination



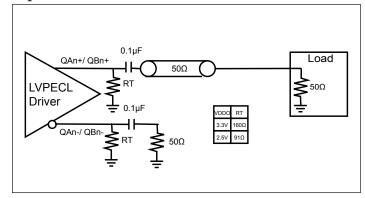
Single Ended LVPECL, DC Couple



Single Ended LVPECL, DC Couple, Thevenin Equivalent



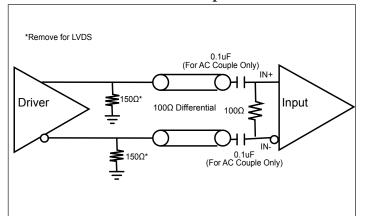
Single Ended LVPECL, AC Couple, Thevenin Equivalent



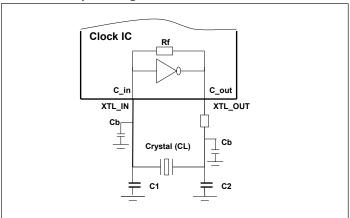




LVPECL/ LVDS AC and DC Input



Clock IC Crystal Input Guide



Part Marking

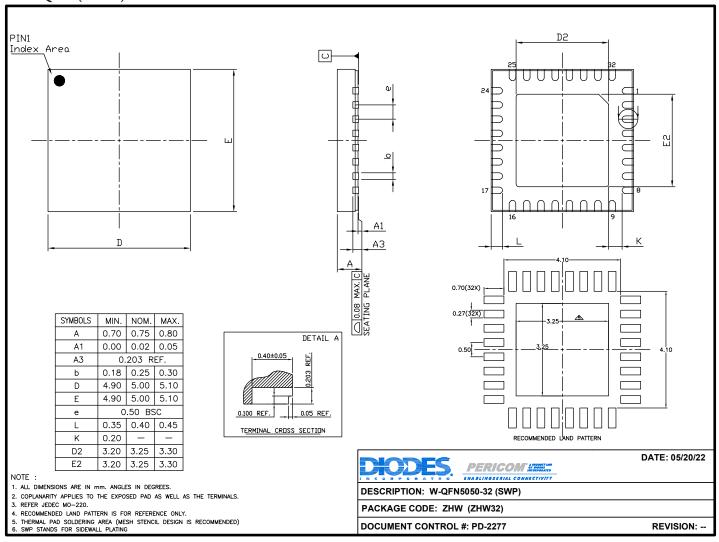
Top mark not available at this time. To obtain advance information regarding the top mark, please contact your local sales representative.





Packaging Mechanical

32-WQFN (ZHW)



For latest package info.

 $please\ check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/packaging-mechanical-and-thermal-characteristics/packaging-mecha$

Ordering Information

Ordering Code	Package Code	Package Description	Operating Temperature
PI6C4921502TQ1ZHWEX	ZHW	32-contact, W-QFN5050-32 (SWP)	-40°C to 125°C
PI6C4921504TQ1ZHWEX	ZHW	32-contact, W-QFN5050-32 (SWP)	-40°C to 125°C

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Q = Automotive Compliant
- 5. 1 = AEC-Q100 Grade Level
- 6. E = Pb-free and Green
- 7. X suffix = Tape/Reel





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